

Features

- * For surface mounted applications
- * Low profile package
- * Glass Passivated Chip Junction
- * Easy to pick and place
- * High Temp Soldering: 260 $^\circ\!\!\!{\rm C}$ for 10seconds at Terminals







SMBF							
DIM.	INC	CHES	MM				
	MIN	MAX	MIN	MAX			
А	0.201	0.217	5.10	5.50			
В	0.138	0.146	3.5	3.7			
С	0.165	0.173	4.2	4.4			
D	0.075	0.087	1.90	2.20			
E	0.043	0.051	1.10	1.30			
F	0.007	0.010	0.18	0.26			
G	0.031	0.047	0.80	1.20			

Mechanical Data

- * Case: SMBF Molded plastic
- * Terminals: Solderable per MIL-STD-750, Method 2026
- * Polarity: Indicated by cathode band

Maximum Ratings and Electrical Characteristics (TA=25 °C unless otherwise noted)

Type Number	Symbols	S2ABF	S2BBF	S2DBF	S2GBF	S2JBF	S2KBF	S2MBF	Unit
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum D.C Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current	I _{F(AV)}	2					А		
Peak Forward Surge Current, 8.3ms single half sine-wave	I _{FSM}	70					А		
Maximum Instantaneous Forward Voltage at 2.0A	V _F	1.1					V		
Maximum D.C Reverse Current @ $T_J=25^{\circ}C$		5							μA
at Rated D.C Blocking Voltage @ T_J =125°C	I _R	100							
Typical Junction Capacitance (Note1)	CJ	25				pF			
Typical Thermal Resistance (Note2)	Reja Rejc				°C/W				
Operating Junction Temperature Range	TJ	-55 to +150			°C				
Storage Temperature Range T _{ST}		-55 to +150						°C	

Note 1:Measured at 1 MHz and applied reverse voltage of 4 V D.C Note 2:P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



Ratings and Characteristic Curves



Fig.1 Forward Current Derating Curve

Fig.2 Typical Reverse Characteristics



Fig.3 Typical Forward Characteristic



Fig.4 Typical Junction Capacitance







S2ABF THRU S2MBF Surface Mount General Purpose Silicon Rectifiers

Ordering Information

Part No.	Package	Packing Code	Packing
S2ABF THRU S2MBF	SMBF	R50	5000pcs/Reel

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